15 JANUARY 1991-I

## Structural effects on the calculated semiconductor gap of CrSi<sub>2</sub>

## L. F. Mattheiss

AT&T Bell Laboratories, Murray Hill, New Jersey 07974 (Received 16 October 1990)

The results of band calculations for hexagonal  $CrSi_2$ , carried out in the local-density approximation, predict an indirect semiconductor gap of 0.30 eV which is in excellent agreement with the measured optical value ( $\sim 0.35$  eV). The calculated gap, which occurs within the Cr 3*d* manifold, is particularly sensitive to the local Cr-Si coordination geometry. It decreases with uniaxial pressure along *c* and vanishes for the alternative sequencing of hexagonal-type CrSi<sub>2</sub> layers that characterize the orthorhombic and tetragonal phases of the refractory (groups IV-VI) transitionmetal disilicides.

Transition-metal silicides have received increased attention in recent years because of their practical importance in silicon-based microelectronics as Schottky barriers and low-resistivity interconnects.<sup>1,2</sup> The refractory disilicides RSi<sub>2</sub> (i.e., those containing groups IV-VI transitionmetal elements R) are especially attractive in such applications because of their high-temperature stability and generally low electrical resistivities. Unlike their cubic group-VIII counterparts CoSi2 and NiSi2, the refractory disilicides RSi<sub>2</sub> form with a variety of complicated, lowsymmetry orthorhombic, hexagonal, and tetragonal structures. Despite their apparent diversity, these phases share a common structural element, namely, nearly hexagonal RSi<sub>2</sub> layers.<sup>3</sup> These compounds also share similar electronic properties<sup>4</sup> (i.e., partially filled d bands near  $E_F$ ), which presumably account for their novel structural and thermal properties.

Although most transition-metal silicides are metallic, a few compounds have been characterized as semiconductors, with typical band gaps in the (0.1-0.9)-eV range.<sup>2</sup> Among these semiconductors, the refractory compound CrSi<sub>2</sub> has been the most extensively studied material since its initial characterization as an 0.35-eV band-gap semiconductor in the mid-1960s.<sup>5</sup> The analysis of subsequent transport data<sup>6</sup> has yielded a slightly smaller estimate ( $\sim 0.30 \text{ eV}$ ) of the CrSi<sub>2</sub> band gap, along with indications of relatively large hole and electron effective-mass ratios ( $m^*/m_0 \sim 3$  and 20, respectively). Such masses seem consistent with the enhanced Cr 3d character near  $E_F$  that is expected for a refractory compound.

Potential optoelectronic device applications that combine semiconductor-semiconductor heterojunctions with silicon-based integrated-circuit technology have stimulated efforts to grow epitaxial CrSi<sub>2</sub> thin films on various faces of Si.<sup>7,8</sup> Despite a favorable lattice match with Si(111), these attempts have produced small grained ( $\sim 2$  $\mu$ m) epitaxial regions that cover only a fraction ( $\sim 70\%$ ) of the total interface. A promising technique for fabricating Si/CrSi<sub>2</sub>/Si heterostructures with improved interfaces utilizes ion implantation to form thin buried layers of CrSi<sub>2</sub> in Si(111) wafers.<sup>9</sup>

At present, a detailed understanding of the nature and origin of the semiconducting gap in  $CrSi_2$  is lacking. One proposal<sup>1</sup> suggests that magnetic influences may be important. Indeed, the results of a band calculation<sup>10</sup> for

hexagonal CrSi<sub>2</sub> predict semimetallic rather than semiconducting behavior. However, recent optical studies<sup>11</sup> have provided convincing evidence that a standard bandlike picture is applicable. According to these measurements, CrSi<sub>2</sub> has an indirect band gap of  $\sim 0.35$  eV, with indications of strong direct transitions at slightly higher ( $\sim 0.67$  eV) energies.

These developments have stimulated the present effort to explore the applicability of a simple band picture for explaining the semiconductor gap in hexagonal CrSi<sub>2</sub>. With this objective, the linear augmented-plane-wave (LAPW) method has been applied to calculate the electronic band structure of bulk hexagonal CrSi2 in the local-density approximation (LDA). The present im-plementation of the LAPW method<sup>12</sup> imposes no shape approximations on either the crystalline charge density or the potential. Exchange and correlation effects are treated with the use of the Wigner interpolation formula.<sup>13</sup> The present calculations include a basis of  $\sim 500$  LAPW's (12 Ry plane-wave cutoff) and spherical-harmonic terms through l=6. The crystalline charge density and potential are expanded with about 5000 plane waves (55 Ry) in the interstitial region and lattice harmonics  $(l_{max}=4)$ within the muffin-tin spheres. A 14-point k mesh in the irreducible  $\frac{1}{24}$  wedge has been used to carry out Brillouinzone integrations.

The essential features of the hexagonal C40 structure are illustrated in Fig. 1. It consists of identical hexagonal CrSi<sub>2</sub> layers which are stacked in an ABC sequence such that successive layers are rotated by 60° about an origin (\*). The intralayer Cr-Si bond lengths ( $\sim 2.55$  Å) are determined by a Si-atom position parameter x. Totalenergy calculations<sup>14</sup> show that deviations from the "ideal"  $x = \frac{1}{6}$  value<sup>15</sup> are minimal ( $\Delta x = 1.5 \times 10^{-4}$ ). The C40 space group  $(D_6^4)$  is nonsymmorphic, containing a screw axis that interchanges layers via the nonprimitive translations  $\tau = 0, c/3$ , and 2c/3.  $E_{n,k}$  exhibits full hexagonal  $(D_{6h})$  symmetry as a result of time reversal.<sup>16</sup> The orthorhombic and tetragonal phases that characterize the other refractory disilicides (see Table I) involve alternative four-layer (ABCD for C54) or two-layer (AB' for C49 and AB for  $C11_b$ ) variations on the three-layer ABC stacking of the hexagonal C40 phase.<sup>3</sup> The ubiquity of these hexagonal RSi<sub>2</sub> layers implies an intrinsic stability that should enhance their epitaxial growth at Si inter1864



FIG. 1. Projected (0001) view of hexagonal C40 CrSi<sub>2</sub> illustrating the *ABC* stacking of hexagonal CrSi<sub>2</sub> layers. Cr (Si) atoms are represented by the large (small) circles; neighboring primitive-cell origins are labeled with \*'s.

faces.

Because the C40 structure contains three formula units per primitive cell, a complex band structure can be anticipated for hexagonal CrSi<sub>2</sub>. These expectations are realized in the LAPW band results which are shown in Fig. 2. As indicated by the triangle symbols, the lowest CrSi<sub>2</sub> bands have predominant Si 3s, 3p character, which then gradually switches to Cr 3d character near  $E_F$ . Within this Cr 3d manifold, an 0.30-eV indirect band gap occurs between the highest filled valence-band state  $E_{n,k}$  at L(n=21) and the lowest unoccupied conduction-band state at M (n=22). This calculated LDA gap is in excellent agreement with the measured 0.35-eV optical gap.<sup>11</sup> However, the calculated lowest-energy direct transition at L is somewhat smaller than the observed value (0.45 vs 0.67 eV).

The origin of the CrSi<sub>2</sub> band gap within the Cr 3d manifold is rather complex, involving the hybridization of specific 3d orbitals with the Si 3p states in neighboring layers. As shown in the upper portion of Fig. 3, states near the valence-band maximum have predominant  $d_{3z^2-r^2}$  symmetry while the conduction-band minimum involves  $d_{xz,yz}$ -type states. Despite substantial d character, the calculated effective masses are close to the freeelectron values for both the valence and conduction bands. Specifically, the principal-axis effective-mass ratios for

TABLE I. Observed crystal structures of the refractory transition-metal disilicides  $RSi_2$  (Ref. 2). O, H, and T denote phases with orthorhombic, hexagonal, and tetragonal symmetry, respectively.

| Series     | IV   | Group<br>V                         | VI                                  |
|------------|--|------------------------------------|-------------------------------------|
| 3d         | $TiSi_2 \\ O(C54)$                           | VSi <sub>2</sub><br><i>H</i> (C40) | CrSi <sub>2</sub><br><i>H</i> (C40) |
| 4 <i>d</i> | ZrSi <sub>2</sub><br><i>O</i> ( <i>C</i> 49) | NbSi <sub>2</sub><br>H(C40)        |                                     |
| 5d         | HfSi <sub>2</sub><br>O(C49)                  | TaSi <sub>2</sub><br>H(C40)        | $\frac{\text{WSi}_2}{T(C11_b)}$     |



FIG. 2. LAPW energy-band results for hexagonal (C40) CrSi<sub>2</sub>. Triangles identify bands with significant Si 3s, 3p orbital weight (>15%) within the Si muffin-tin spheres.

holes [electrons] at L [M] are (1.2, 1.3, 0.9) [0.7, 0.7, 1.4]. These are significantly smaller than the corresponding experimental values of  $\sim 3[20]$ .<sup>6</sup> Clearly, independent measurements would be useful in clarifying this discrepancy.

The excellent agreement between the calculated CrSi<sub>2</sub> band gap and experiment is unanticipated, since the LDA greatly underestimates semiconductor band gaps in many other systems. Its success in CrSi<sub>2</sub> may be understood in terms of the analysis of the many-body self-energy operator given by Godby, Schlüter, and Sham.<sup>17</sup> They showed that the spatial nonlocality of this operator was the dominant characteristic which produced accurate band gaps. When integrated against the relatively smooth valenceband wave functions, it produced a more attractive effective potential than the more rapidly oscillating conduction-band functions.<sup>17</sup> While such qualitative differences between the valence- and conduction-band states are found in the conventional group IV and III-V semiconductors, the dominant spatial scale of nearby states on both sides of the CrSi<sub>2</sub> band gap is the same, set by the Cr 3d orbitals. As noted above, the CrSi<sub>2</sub> gap originates from a subtle combination of hybridization and crystalfield effects which do not modify significantly the shape of the high-amplitude 3d portion of these wave functions. It is, therefore, plausible that the state dependence of the self-energy should be small within this group of bands, and the band splittings accurately represented by the LDA potential.<sup>1</sup>

Because of its small value, one can expect the calculat-

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FIG. 3. LAPW energy-band results near  $E_F$  for hexagonal CrSi<sub>2</sub>. Bands with specific 3*d*-orbital character are distinguished by squares  $(d_{x_2,y_2} > 15\%)$ , triangles  $(d_{x_2,y_2} > 30\%)$ , and x's  $(d_{x_1,x_2} > 30\%)$ . Calculated dependence of the CrSi<sub>2</sub> band gap  $E_{gap}$  on the Si-atom position parameter x.

ed CrSi<sub>2</sub> band gap to be sensitive to both structural and chemical changes. Substantially reduced gaps are calculated <sup>14</sup> for the metastable C40 phases of  $MoSi_2$  (+0.02 eV) and WSi<sub>2</sub> (-0.03 eV). Analogous calculations show that a 2% reduction in the CrSi<sub>2</sub> c-axis lattice parameter causes an 8-meV decrease in the band gap. The calculated gap is particularly sensitive to the Si-atom position parameter x that determines the Cr-Si coordination geometry within each CrSi2 layer. In the results presented thus far, this parameter has been fixed at its ideal  $x = \frac{1}{6}$  value, where each Si atom has six equidistant planar neighbors. The dependence of the CrSi<sub>2</sub> band gap  $E_{gap}$  on small  $\Delta x$  variations is shown in the lower portion of Fig. 3. It is seen that  $E_{gap}$  varies by  $\sim 0.1 \text{ eV}$  for  $\Delta x$ changes of  $\pm 0.01$ . However, the resulting increase in the predicted  $CrSi_2$  band gap is minimal (~1 meV) for the calculated shift,  $^{14}\Delta x \approx 1.5 \times 10^{-4}$ .

The effect of stacking sequence changes on the CrSi<sub>2</sub> bands near  $E_F$  is illustrated in Fig. 4. In these calculations, lattice parameters for the tetragonal  $C11_b$  and orthorhombic C54 phases have been derived from the C40 values<sup>15</sup> (a = 4.420 Å, c = 6.349 Å) using the relations  $a_t = \sqrt{2}a/2$ ,  $c_t = \sqrt{3}a$ , and  $a_0 = \sqrt{3}a$ ,  $b_0 = a$ ,  $c_0 = 4c/3$ . These parameters preserve the C40 intraplanar CrSi<sub>2</sub> bond distances in both phases. Tetragonal symmetry increases the C40 CrSi<sub>2</sub> interlayer separation from 2.12 to



FIG. 4. Effect of alternative layer sequencing on the  $CrSi_2$  bands near  $E_F$ , including the AB and ABCD stacking of the tetragonal (C11<sub>b</sub>) and orthorhombic (C54) phases. The squares identify bands with dominant Cr 3d orbital character (d > 50%).

2.21 Å for the  $C11_b$  phase. However, the C40 geometry is changed only in the fourth layer (~8.5 Å) in the C54 calculation.

As shown by the results in Fig. 4, both hypothetical forms of CrSi2 exhibit semimetallic behavior. The tetragonal  $(C11_b)$  results are in good agreement with those<sup>19</sup> for the isostructural compounds MoSi2 and WSi2. In the C54-phase results, the slight ( $\sim 0.05 \text{ eV}$ ) band overlap is the result of increased hybridization of the Cr 3d states with Si 3p orbitals. Thus, a subtle combination of symmetry and distant-neighbor ( $\sim 8.5$  Å) coordination changes is sufficient to eliminate the C40 CrSi<sub>2</sub> band gap. The calculations show that the total energies of all three CrSi<sub>2</sub> phases are comparable, with the  $C11_b$  (~0.01 eV/formula unit) and C54 ( $\sim$ 0.1 eV/formula unit) phases slightly less stable than C40 CrSi<sub>2</sub>. This suggests the possible presence of low-energy stacking faults in thin-film CrSi<sub>2</sub> samples, a potential detriment in device applications that exploit the semiconducting properties of bulk CrSi<sub>2</sub>.

To summarize, band calculations confirm that hexagonal CrSi<sub>2</sub> is a small-gap semiconductor, yielding a band gap of 0.30 eV which is in excellent agreement with experiment. This calculated gap is sensitive to subtle structural-symmetry variations that transform the C40 phase into the closely related C54 and C11<sub>b</sub> structures. 1866

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I am pleased to acknowledge several useful discussions with D. R. Hamann during the course of this investigation.

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